

1 Scope:

- 1.1 This specification is applicable to lead free and halogen free of RoHS directive for RAW series wide terminal Low-Resistance thick film chip resistors.
- 1.2 This product is for automotive electronic application.
- 1.3 AEC-Q200 qualified , grade 0.

2 Explanation Of Part Number:

(EX)

RAW				R100	ſ
Туре	Size	Packaging	No	ominal Resistance	Resistance Tolerance
Wide Terminal Low-Resistance Thick Film Chip Resistors for Automotive Grade	0508 0612 1218 1020 1225	T:Taping Type	4-Digit	EX. 0.1Ω=R100	F=± 1% J=± 5%

3 General Specifications:

	Rated	Max.	Max		Resistance Range
Туре	Power at 70℃	Rated Current	Overload ^{Ta} Current	bing _{Type} T.C.R (ppm / ℃)	F(±1%) ∖ J((±5%) E-24 ∖ E-96
				±800	$10m\Omega \leq R < 30m\Omega$
RAW	1	570		±400	$30m\Omega \leq R < 56m\Omega$
(0508)	$\frac{1}{2}W$	5.7A	14.4A	±250	$56m\Omega \leq R < 180m\Omega$
				±200	$180m\Omega \leq R < 1\Omega$
				0~+300	$10m\Omega \leq R < 22m\Omega$
				0~+200	$22m\Omega \leq R < 47m\Omega$
RAW (0612)	1W	10A	25A	0~+150	$47m\Omega \leq R < 100m\Omega$
(0012)				0~+200	$100m\Omega \leq R < 220m\Omega$
				±200	$220m\Omega{\leq}R{<}1\Omega$
RAW (1218)	1W	10A	25A	±2000	$10m\Omega{\le}R{<}30m\Omega$
				±1000	$30m\Omega{\le}R{<}56m\Omega$
				±700	$56m\Omega \leq R < 180m\Omega$
				±250	$180m\Omega \leq R < 1\Omega$
				±800	$10m\Omega{\le}R{<}30m\Omega$
RAW	4344	10A	25A	±400	$30m\Omega{\le}R{<}56m\Omega$
(1020)	1W		20A	±200	$56m\Omega \leq R < 180m\Omega$
				±200	$180m\Omega \leq R < 1\Omega$
				±800	$10m\Omega{\le}R{<}30m\Omega$
RAW	2W	14.14A	25.254	±400	$30m\Omega{\leq}R{<}56m\Omega$
(1225)	ZVV	14.14A	35.35A	±200	$56m\Omega \leq R < 180m\Omega$
				±200	$180m\Omega \leq R < 1\Omega$
Operating Temperature Rang			nge		-55℃ ~+155℃
	IE		QA	Remark	
n		Approved	Signing		Issue Dep.DATA C

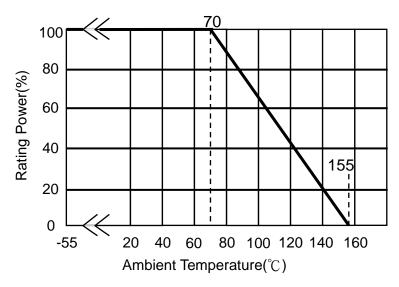
IE			QA	Remark	Issue Dep. DATA Center.	
Written			IT'S NOT UNDER CONTROL FOR PDF FILE			
朱翠平	上版伟	3 JA	公 12页	PLS NOTE THE VERSION STATED	Series No. 60	
		0		Do not copy without permission	Series No.	



3.1 Power Derating Curve:

Operating Temperature Range : - 55∼155 °C

For resistors operated in ambient temperatures above 70 $^\circ\!C$, power rating shall be derated in accordance with figure below $_\circ$



3.2 Current Rating:

Rated Current: DC current or AC current (rms) based on the rated power.

The current can be calculated by the following formula. If the calculated value exceeds the Max. current specified in the Table 3, the Max. current rating is set as the current rating.

$$I = \sqrt{P/R}$$

I= Rated current (A) P= Power rating (w) R= Nominal resistance(Ω)

4 Dimensions:

							Unit:mm
	Туре	Dimension Size Code	L	W	Н	L1	L2
R 500	RAW	0508	1.20±0.10	2.00±0.10	0.50±0.10	0.20±0.10	0.20±0.15
0	RAW	0612	1.60±0.20	3.20±0.20	0.55±0.10	0.35±0.15	0.25±0.15
	RAW	1218	3.10±0.10	4.60±0.20	0.55±0.10	0.45±0.25	0.40±0.20
ř-	RAW	1020	2.50±0.20	5.00±0.20	0.55±0.10	0.25±0.20	0.90±0.20
	RAW	1225	3.20±0.20	6.40±0.20	0.55±0.10	0.45±0.20	0.75±0.20

Remark	IT'S NOT UNDER CONTROL FOR PDF FILE PLS NOTE THE VERSION STATED	Issue Dep. DATA Center.
		Series No. 60
	Do not copy without permission	

	RAW Series Low-Resistance Thick Film C	hip Document No.	IE-SP-139
(ABCC)	Resistors Product Specification	Released Date	2021/07/07
아비코전자	(Automotive Grade)	Page No.	3
5 Struc	ture Graph:		
	Bottom side		
		4 3 5 6	
	Top Side		
	R220	2	
	1 Caramia aubatrata	and Drotactive coating	

1	Ceramic substrate	6	2nd Protective coating
2	1st Top inner electrode	7	G2 layer+Marking
3	Resistive layer	8	Terminal inner electrode
4	Bottom inner electrode	9	Ni plating
5	1st Protective coating	10	Sn plating

lemark	IT'S NOT UNDER CONTROL FOR PDF FILE PLS NOTE THE VERSION STATED	Issue Dep. DATA Center.
	Do not copy without permission	Series No. 60



RAW Series Low-Resistance Thick Film Chip
Resistors Product Specification
(Automotive Grade)Document No.IE-SP-139Released Date2021/07/07Page No.4

6 Reliability Test:

o ivei	ability	Test:	
lte	em	Conditions	Specifications
Hi	igh erature		Resistors 1%
	orage)	Experiment evidence: AEC-Q200	
	erature cling	Put the specimens in the High & low temperature test chamber with temperature varies from -55° to 125° for 15 minutes and total 1000 cycles. Take them out to stabilize in room temperature for $24\pm4hr$ or more, and measure of its resistance variance rate.	1%
	Experiment evidence: AEC-Q200 RAW05/06/18/20 applied 2.0 times rated current for 5 seconds ,RAW25 applied 2.0 times rated current for 2 seconds ,release the load for about 30 minutes, then measure its resistance variance rate. (Rated current refer to item 3. general specifications)		1%
Biased	Humidity	Refer to JIS-C5201-1 4.13 Solder the specimens on the test PCB and put them into the constant temperature humidity chamber with 85±2°C and 85±5%RH. Then apply the test voltage that calculates based on the 10% of rated power for 1000hrs. Then take them out to stabilize in room temperature for 24±4hr or more, and measure of its resistance variance rate.	1%
	ational ife	Experiment evidence: AEC-Q200 Solder the specimens on the test PCB and put them in the chamber with temperature of $125\pm3^{\circ}$ C and load the current for 1000 hours. Then take them out to stabilize in room temperature for 24±4hr or more, and measure of its resistance variance rate. Note: The input current shall refer to the power derating curve (referring to page 2,No.3.2)	1%
	tance to ing Heat	Experiment evidence: AEC-Q200 The specimens are fully immersed into the Pb-free solder pot, then take them out to stabilize for 1 hour or more and measure of its resistance variance rate. Temp of solder pot : $260\pm5^{\circ}$ C. Soldering duration : 10 ± 1 sec.	∆R%=±2.0%
L		Experiment evidence AEC-Q200	
		IT'S NOT UNDER CONTROL FOR PDF FILE PLS NOTE THE VERSION STATED	Issue Dep. DATA Center.
Remark		Do not copy without permission	Series No. 60



RAW Series Low-Resistance Thick Film Chip
Resistors Product Specification
(Automotive Grade)Document No.Released Date2Page No.Page No.

IE-SP-139 2021/07/07

5

	Item		Conditions			Specifications Resistors
	ESD	(2)discharges one (1) with a negative pola 30min or mor rate. The test discharge mo	mens on the test fixture and two (2KVDC) shall be applied to each a positive polarity and one (1) with rity. Afterwards, the specimens sta e and measure of its resistance va- is performed with direct contact a ode. The resistor and capacitor use 2000 Ω and 150pF respectively.	a abilize for ariance ad regular	△R=±3.0%	
	Solderability	Test method Test item 1 (Precondition: The specime 4hrs \pm 15min. The specime immersed inte 235 \pm 5°C for observe the s Test item 2 (The specime immersed inte 260 \pm 5°C for observe the s	solder pot test): Method B hs are subjected to 155°C dry bak hs are immersed into the flux first, to the solder pot, at a temperature 5+0/-0.5 sec. Then rinse with wat coldering coverage under the micro Leaching test): Method D hs are immersed into the flux first, to the solder pot, at a temperature 30+0/-0.5 sec. Then rinse with wat coldering coverage under the micro	then fully of er and oscope. then fully of er and	2.At the edge	coverage over 95% e of terminal, the object h (e.g. white ceramic) shall e.
C	Electrical Characterization	TCR (ppm / R1: Resistand R2: Resistand T1: Room ten T2: Temperat	vidence AEC-Q200 $\widehat{\ }^{(R2-R1)}_{\mathbb{C}} = \overline{R^{1}(T2-T1)} \times 10^{6}$ se at room temperature (Ω) se at -55°C or +125°C(Ω) hperature (°C) ure -55°C or +125°C vidence: AEC-Q200		Refer to item	3. general specifications
		Solder the sp onto the Bend PCB, and the 60 (+ 5) Sec. load. Bending dept D:0508 \ 061 1218 \ 102	ecimens on the test PCB and put ding Tester. Add force at the centra duration of the applied forces sha Measure of its resistance variance h	al part of Il be		al damage, peel-off of side
Rer	nark	IT	'S NOT UNDER CONTROL FOR PDF FIL PLS NOTE THE VERSION STATED			Issue Dep.DATA Center.
]	Do not copy without permission			Series No. 60



RAW Series Low-Resistance Thick Film ChipDocument No.IE-SP-139Resistors Product Specification
(Automotive Grade)Released Date2021/07/079996

7 Measurement Point:

Bottom electrode			Unit : mm
B	DIM TYPE	Α	В
• • •	RAW (0508)	1.05±0.05	0.78±0.05
Α	RAW (0612)	1.35±0.05	1.30±0.05
	RAW (1218)	2.80±0.05	2.00±0.05
O Current Treminal O Voltage Treminal	RAW (1020)	2.10±0.05	2.40±0.05
U manage in second	RAW (1225)	2.90±0.05	3.00±0.05

8 Plating Thickness:

- 8.1 Ni: \geq 2 μ m
- 8.2 Sn(Tin): \geq 3 μ m
- 8.3 Sn(Tin):Matte Sn

9 Rule of package empty quantity:

9.1 Empty quantity for each reel is not allowed to exceed 0.1% of the whole quantity, and continuous 2pcs (included) empty are also unallowed.

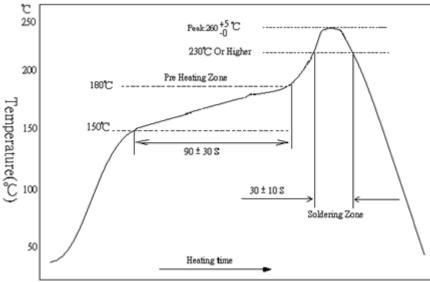
Remark	IT'S NOT UNDER CONTROL FOR PDF FILE PLS NOTE THE VERSION STATED	Issue Dep. DATA Center.
	De not convusitheut normicaion	Series No. 60
	Do not copy without permission	

	RAW Series Low-Resistance Thick Film Chip	Document No.	IE-SP-139
BCO	Resistors Product Specification	Released Date	2021/07/07
아비코전자	(Automotive Grade)	Page No.	7

10 Technical application notes: (This is for recommendation, please customer perform adjustment according to actual application)

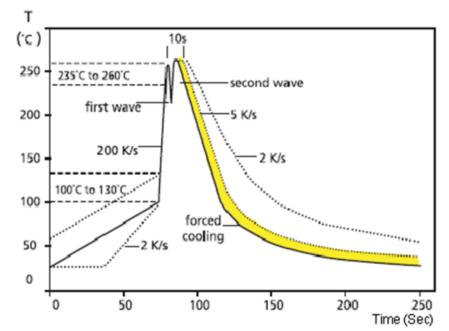
10.1 Recommend Soldering Method:

10.1.1 Lead Free IR Reflow Soldering Profile (MEET J-STD-020D)



Remark: The peak temperature of soldering heat is 260 +5/-0 $\,\,^\circ\!\mathrm{C}\,$ for 10 seconds.

10.1.2 Lead Free Double-Wave Soldering Profile.(This applies to 0603 size inclusive above products)



10.1.3 Soldering Iron: temperature $350^{\circ}C \pm 10^{\circ}C$, dwell time shall be less than 3 sec.

Remark	IT'S NOT UNDER CONTROL FOR PDF FILE PLS NOTE THE VERSION STATED	Issue Dep. DATA Center.
	Do not copy without permission	Series No. 60

	RAW Series Low-Resistance Thick Film Chip	Document No.	IE-SP-139
9	RAW Series Low-Resistance Thick Film Chip Resistors Product Specification	Released Date	2021/07/07
	(Automotive Grade)	Page No.	8

10.2 Recommend Land Pattern Design (For Reflow Soldering)

When a component is soldered, the resistance after soldering changes slightly depending on the size of the soldering area and the amount of soldering. When designing a circuit, it is necessary to consider the effect of a decrease or increase in its resistance.

				Unit:mm
	DIM	A	В	С
с	RAW (0508)	0.6	2.2	2.3
C I	RAW (0612)	0.7	2.6	3.5
	RAW (1218)	1.9	4.1	4.9
B	RAW (1020)	0.5	3.5	5.3
<u>↓</u>	RAW (1225)	1.3	4.2	6.4

10.3 Automobile Electronic Application:

This specification is for automobile electronic use. RALEC will take no responsibility if any damage, cost or loss occurs when the product has been used in any special circumstances.

- (a) Information , entertainment , navigation , audio control units.
- (b) Comfortable door, window, seat control unit.
- (c) Internal lighting control unit.

10.4 Environment Precautions:

If consumer intends to use our company product in special environment or condition (including but not limited to those mentioned below), then will need to make individual recognition of product features and reliability accordingly.

- (a) Used in high temperature and humidity environment
- (b) Exposed to sea breeze or other corrosive gas, such as Cl2 · H2S · NH3 · SO2 and NO2.
- (c) Used in non-verified liquids including water, oil, chemical and organic solvents.
- (d) Using non-verified resin or other coating material to seal or coat our Company product.
- (e) After soldering, it is necessary to use water-soluble detergents to clean residual solder fluxes, even though no-clean fluxes are recommended.

PLS NOTE THE VERSION STATED	ssue Dep. DATA Center.
	Series No. 60



10.5 Momentary Overload Precautions:

The product might be out of function when momentary overloaded. Please make sure to avoid momentary overloading while using and preserving.

- 10.6 Operation and Processing Precautions:
 - (a) Avoid damage to the edge of resistor and protective layer caused by mechanical stress.
 - (b) Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
 - (c) Make sure the power rating is under the limit when using the resistor. When power rating is over the limit, the resister will be overloaded. There might be machinery damage due to the climbing temperature
 - (d) If the resister will be exposed under massive impact load (shock wave) in a short period of time, the working environment must be set up well before use.
 - (e) Please make evaluation and confirmation when the product is well used in your company and have a through consideration of its fail-safe design to ensure the system safety.

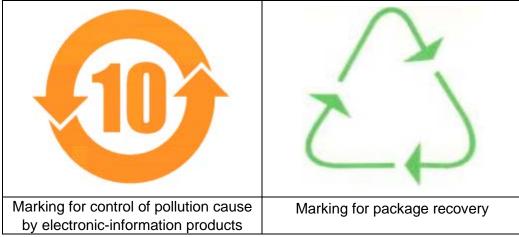
11 Storage and transportation requirement:

- 11.1 The temperature condition must be controlled at 25±5℃, the R.H. must be controlled at 60±15%. The stock can maintain quality level in two years.
- 11.2 Please avoid the mentioned harsh environment below when storing to ensure product performance and its' weldability. Places exposed to sea breeze or other corrosive gas, such as Cl2 H2S NH3 SO2 and NO2.
- 11.3 When the product is moved and stored, please ensure the correct orientation of the box. Do not drop or squeeze the box. Otherwise, the electrode or the body of the product may be damaged.

Remark	IT'S NOT UNDER CONTROL FOR PDF FILE PLS NOTE THE VERSION STATED	Issue Dep. DATA Center.
	Do not copy without permission	Series No. 60



12 The carton packaged for electronic-information products is made by the symbol as follows: (For china)



13 Attachments:

13.1 Document Revise Record (QA-QR-027)

Remark	PLS NOTE THE VERSION STATED	Issue Dep.DATA Center.
		Series No. 60
	Do not copy without permission	



Legal disclaimer

RALEC, its distributors and agents (collectively, "RALEC"), hereby disclaims any and all liabilities for any errors, inaccuracies or incompleteness contained in any product related information, including but not limited to product specifications, datasheets, pictures and/or graphics. RALEC may make changes, modifications and/or improvements to product related information at any time and without notice.

RALEC makes no representation, warranty, and/or guarantee about the fitness of its products for any particular purpose or the continuing production of any of its products. To the maximum extent permitted by law, RALEC disclaims (i) any and all liability arising out of the application or use of any RALEC product, (ii) any and all liability, including without limitation liability for any loss of profits or for direct, indirect, special, punitive, consequential or incidental damages arising out of or related to RALEC products, and (iii) any and all implied warranties, including warranties of fitness for a particular purpose, non-infringement and merchantability.

RALEC defined this product is for automotive electronic use , not design for any application for medical life-saving or life support equipment, or any application which may inflict casualties if RALEC product failure occurred. Any and all technical advice furnished by RALEC with reference to the use of RALEC products are given free of charge and RALEC assumes no obligation or liability for the advice given or results obtained, and all such advice are given and accepted at buyer's risk. Buyer shall assume all risk and liability for the results obtained by the use of any RALEC products in combination with other articles or material or in the practice of any process, regardless of any oral or written technical statement made by RALEC with respect to the use of such products by way of technical advice or otherwise. Further, buyer represents and warrants that it has the experience and capacity of determining the correct product for its intended application.

Information provided here is intended to indicate product specifications only. RALEC reserves all the rights for revising this content without further notification, as long as products are unchanged. Any product change will be announced by ECN.

 Remark
 It's NOT UNDER CONTROL FOR PDF FILE PLS NOTE THE VERSION STATED..
 Issue Dep.DATA Center.

 Do not copy without permission
 Series No.60